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Date: August 1, 2003  
Signature: Janita C. Beall  
Janita C. Beall

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Shing Yeh et al.

Group Art Unit: 1742

Serial No. 10/099,861

Examiner: Jenkins

Filed: March 15, 2002

Title: LEAD-FREE SOLDER ALLOY AND SOLDER REFLOW PROCESS

STATEMENT ACCOMPANYING  
INFORMATION DISCLOSURE STATEMENT

Applicant(s) requests the Examiner to consider and make of record the reference(s) and/or information on attached PTO 1449.

**CHECK ONE: (A, B, or C.)**

☒ A. This statement is submitted within 1) three months after the filing date (even if after the first action); or 2) within three months of the date of entry of the national stage or 3) before the mailing date of a first Office Action. No fee or statement is required.

☐ B. This statement is submitted after the period specified in para. A, but before Final Office Action or Notice of Allowance or the close of prosecution.

**CHECK ONE: (1, 2, or 3)**

☒ 1. I hereby state that each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement; or

☐ 2. I hereby state that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in § 1.56 (c) more than three months prior to the filing of the information disclosure statement.

☐ 3. Charge the fee set forth in § 1.17(p) to Delphi Technologies, Inc. Deposit Account No. 50-0831.

☐ C. This statement is submitted after a Final Office Action or Notice of Allowance or the close of prosecution, but before payment of the issue fee. Charge the fee set forth in § 1.17(p) to Delphi Technologies, Inc. Deposit Account No. 50-0831.

**CHECK ONE: (1 or 2)**

☐ 1. I hereby state that each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement; or

☐ 2. I hereby state that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in § 1.56 (c) more than three months prior to the filing of the information disclosure statement.

**REMARKS UNDER 1.98 (a)(3)**

Please consider the attached reference(s) which have come to the attention of Applicants since the last submission of an IDS. If any fee should be required, please charge the appropriate fee to Delphi Technologies, Inc. Deposit Account No. 50-0831.

Respectfully submitted,



Stefan V. Chmielewski  
Reg. No. 39941  
telephone (248) 813-1220